

Printed: Oct 11, 2021

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	PRODUCT NO.	POS	DIM X	DIM Y	DIM Z	DIM A	DIM B	DIM W	POL. POS	CONTACT PLATING	SOLDERTAIL PLATII	
	928 3-00	2XI9	36	38	34	3.4	5.4	2.1	-	0.38um MIN GXT	0.38um MIN GXT	
	- 0 0 2	2 X 8	4	16	12	3.4	5.4	2.1	-	0.38um MIN GXT	0.38um MIN GXT	
	- 0 0 3	2XI5	28	30	26	3.5	6.5	2.4	-	0.38um MIN GXT	0.38um MIN GXT	
А	- 0 0 4	2 X 7	2	4	10	3.4	2.0	2.0	-	0.38um MIN Au	0.38um MIN Au	
	- 0 0 5	2 X 8	4	16	12	3.4	2.0	2.0	-	0.38um MIN Au	0.38um MIN Au	
	- 0 0 6	2 X I 2	22	24	20	3.6	5.5	2.1	-	0.38um MIN GXT	0.38um MIN GXT	
	- 0 0 7	2 X 2 0	38	40	36	4.0	9.5	2.1	-	0.38um MIN GXT	0.38um MIN GXT	
	- 008	2 X 4	6	8	4	5.5	2.0	2.1	-	0.38um MIN Au	0.38um MIN Au	
	- 0 0 9	2 X 8	4	16	12	4.7	2.0	2.0	-	0.38um MIN GXT	0.38um MIN GXT	
	- 0 0	2 X I 2	22	24	20	4.0	5.5	2.0	-	0.38um MIN GXT	0.38um MIN GXT	
	- 0	2 X I O	18	20	16	4.0	5.5	2.0	-	0.38um MIN GXT	0.38um MIN GXT	
	- 0 2	2XI6	30	32	28	4.0	2.0	2.0	-	0.38um MIN GXT	0.38um MIN GXT	
В	- 0 3	2 X 5	8	10	6	3.5	0	2.0	-	0.76um MIN GXT	0.76um MIN GXT	
	- 0 4	2 X 4	6	8	4	4.0	5.5	2.0	-	0.38um MIN GXT	0.38um MIN GXT	
	-015	2XI5	28	30	26	4.0	5.5	2.0	-	0.38um MIN GXT	0.38um MIN GXT	
	- 0 6	2XI3	24	26	22	4.0	4.0	2.0	-	0.38um MIN GXT	0.38um MIN GXT	
	- 0 7	2XI8	34	36	32	4.0	4.0	2.0	-	0.38um MIN GXT	0.38um MIN GXT	
77	- 0 8	2 X 6	10	12	8	2.8	Ι.Ο	2.0	-	0.38um MIN GXT	0.38um MIN GXT	
ŝÖ	- 0 9	2XI5	28	30	26	6.0	4.0	2.0	-	0.38um MIN GXT	0.38um MIN GXT	
Amphen	- 0 2 0	2XI5	28	30	26	4.0	6.0	1.8	-	0.38um MIN GXT	0.38um MIN GXT	
Ĕ	- 0 2	2 X I 3	24	26	22	4.0	2.0	1.8	-	0.38um MIN GXT	0.38um MIN GXT	
A C	- 0 2 2	2 X I 4	26	28	24	2.0	6.5	2.4	-	0.38um MIN GXT	0.38um MIN GXT	
	- 0 2 3	2 X 2 5	48	50	46	4.0	5.4	2.1 -		0.38um MIN GXT	0.38um MIN GXT	
	- 0 2 4	2XI5	28	30	26	3.4	2.0	2.0	-	0.38um MIN Au	0.38um MIN Au	
u	- 0 2 5	2 X 3	4	6	2	4.0	2.0	2.0 -		0.76um MIN Au	0.76um MIN Au	
Corporation 	- 0 2 6	2 X I 3	24	26	22	4.0	4.0	2.1	-	0.76um MIN GXT	0.76um MIN GXT	
	- 027	2 X 4	6	8	4	4.65	8.7	2.0	-	0.38um MIN Au	0.38um MIN Au	

Corporation	
Amphenol	
© 2020	D

projection dr wcadmin, wcadm 2010/11/01 eng <mark>Yuan-Yuan Bao</mark> chr - $\bigoplus - \subset$ 2021/09/29 appr Tim Yao 2021/10/11 product fami MINITEK II R/R Amphenol FCi SMT STR HDR WITH LOCATOR amphenol-icc.com cat. no. 3 PDS: Rev :BC

Creo File:ELX-WC-A3C,REV F,2020-12-21

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	PRODUCT NO.	POS	DIM X	DIM Y	DIM Z	DIM A	DIM B	DIM W	POL. POS	CONTACT PLATING	SOLDERTAIL PLA	TING	MATERIAL	
	92813-028	2 X 5	8	10	6	4.0	2.0	2.0	-	0.76um MIN GXT	0.76um MIN G	ίΧТ	SEE NOTE I	
	- 0 2 9	2 X 2 2	42	44	40	4.0	6.0	2.0	-	0.38um MIN GXT	0.38um MIN G	ίXТ	SEE NOTE I	
	- 0 3 0	2 X 7	12	4	10	3.4	2.0	2.0	-	0.38um MIN GXT	0.38um MIN G	ίXТ	SEE NOTE I	
A	- 0 3	2 X I 5	28	30	26	3.4	2.0	2.0	-	0.38um MIN GXT	0.38um MIN G	ijХТ	SEE NOTE I	
	- 0 3 2	2 X 4	6	8	4	4.5	3.0	2.25	-	0.76um MIN Au	2.54um MIN 100	% Sn	SEE NOTE I	
	- 0 3 3	2XI6	30	32	28	4.1	3.7	2.25	-	0.76um MIN Au	2.54um MIN 100	% Sn	SEE NOTE I	
	- 0 3 4	2 X I 6	30	32	28	3.7	0.5	2.25	-	0.76um MIN Au	2.54um MIN 100	% Sn	SEE NOTE I	
	-035	2 X 4	6	8	4	4.0	4.4	2.00	-	0.38um MIN Au	0.38um MIN A	Au	SEE NOTE I	
	-036	2 X 2 0	38	32	28	4.0	6.5	2.00	-	0.38um MIN GXT	0.38um MIN G	ίXТ	SEE NOTE I	
	-037	2 X I 4	26	28	24	4.0	9.5	2.1	-	0.76um MIN Au	2.54um MIN 100	% Sn	SEE NOTE I	
	- 0 3 8	2 X I 4	26	28	24	4.0	9.5	2.1	-	0.76um MIN GXT	2.54um MIN 100	% Sn	SEE NOTE I	
	- 0 3 9	2 X I O	18	20	16	4.1	3.75	2.1	-	0.76um MIN GXT	2.54um MIN 100	% Sn	SEE NOTE I	
В	- 040	2 X 5	8	10	6	4.0	5.0	2.1	-	0.76um MIN GXT	2.54um MIN 100	% Sn	SEE NOTE I	
	-04	2XI5	28	30	26	4.0	5.5	2.0	-	0.76um MIN GXT	0.76um MIN G	БХТ	SEE NOTE I	
	- 0 4 2	2 X 8	4	16	12	4.0	11.5	2.1	-	0.38um MIN GXT	0.38um MIN G	ίXТ	SEE NOTE I	
	- 0 4 3	2 X 2 2	42	44	40	4.0	11.5	2.1	-	0.38um MIN GXT	0.38um MIN G	iХТ	SEE NOTE I	
	- 0 4 7	2 X 7	12	4	10	4.0	0.5	2.1	-	0.76um MIN GXT	2.54um MIN 100	% Sn	SEE NOTE I	
	- 0 4 9	2 X I 4	26	28	24	4.0	0.5	2.1	-	0.76um MIN GXT	2.54um MIN 100	% Sn	SEE NOTE I	
)	-050	2 X 5	8	10	6	4.1	3.75	2.1	-	0.76um MIN GXT	2.54um MIN 100	% Sn	SEE NOTE I	
	- 0 5	2 X 4	6	8	4	3.8	4.03	2.1	-	GOLD FLASH	2.54um MIN 100	% Sn	SEE NOTE I	
	- 0 5 2	2 X 4	6	8	4	3.43	7.3	2.1	-	GOLD FLASH	2.54um MIN 100	% Sn	SEE NOTE I	

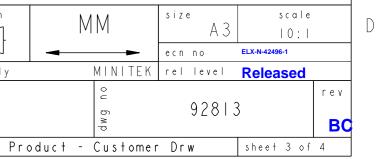
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wcadmin, wcadm 2010/11/01 projection dr eng <mark>Yuan-Yuan Bao</mark> chr - \bigoplus 2021/09/29 \subset 2021/10/11 appr Tim Yao product family Amphenol FCi MINITEK II R/R SMT STR HDR WITH LOCATOR amphenol-icc.com cat. no. 3 PDS: Rev :BC

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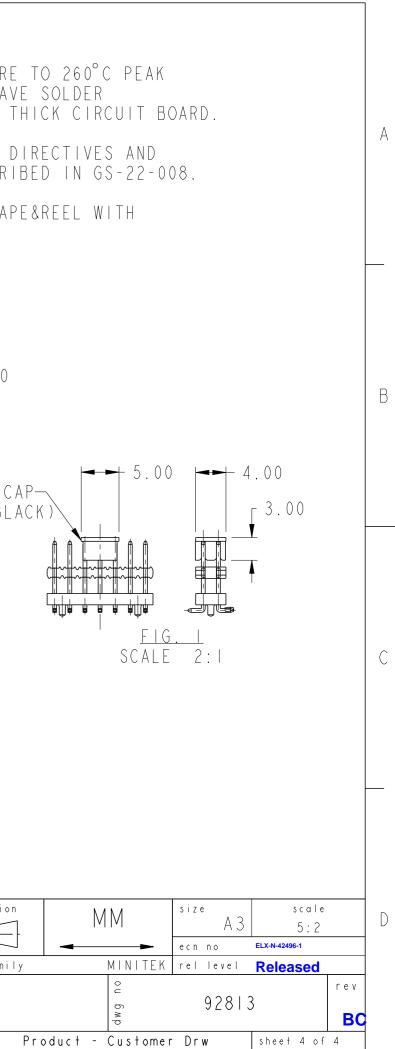
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					Amphenol MINITEK II R/R
© 2020 Amphenol Corporation					drwcadmin, wcadm2010/11/01projectionengYuan-Yuan Bao2021/09/29Image: Chr - Image: Chr
Corporation 		THE HOUSING WILL WITHSTAND E TEMPERATURE FOR IO SECONDS I OR VAPOR PHASE REFLOW OVEN			<u>RECOMMENDED PAD LAYOUT</u>
Amp ^C		P/N:928I3-XXXLF IS SAME TO 9 IS ADDED JUST FOR EASY LEAD	FREE IDENTIFICATION.		$\square \square $
Amphenol	9.	PRODUCT PART NUMBER DESCRIPT 92813 - XXX LF T LEAD FREE. S	SEE NOTE IO		COLOR BLA
	8.		IN TAPE & REEL WITH PICK-UP CAP HE PRODUCT. SEE FIG. I.		PICK-UP CA
В		P/N 928I3-XXXT TO BE PACKED P/N 928I3-0IITC, 0I4TC, 023TO WITH PICK-UP CAP INSTALLED I SEE FIG. I.	C & 024TC TO BE PACKED IN TUBE		NON-ACCUM 0.85 ^{+0.10}
		POLARISATION BY OMISSION OF REFER TO TABLE.			┝━━━━┿ 2.0±0.1
	3.	DIM 1.0 \pm 0.15 APPLIES TO MOL SIDE(S) ARE BROKEN, DIM 1.5 I RECESS APPLIES TO MOLDED SID	MAX APPLIES.	4.	PN 928I3-04ITRS TO BE PACKED IN TAP PICK-UP(L*W=8MM*7MM)
A		TOLERANCE UNLESS OTHERWISE NO		3.	THIS PRODUCT MEETS EUROPEAN UNION D OTHER COUNTRY REGULATIONS AS DESCRI
А	Ι.	MATERIAL: BODY : HIGH TEMPERATURE THER PIN : COPPER ALLOY	MOPLASTIC, UL 94V-0 NATURAL	12.	THE HOUSING WILL WITHSTAND EXPOSURE TEMPERATURE FOR IO SECONDS IN A WAV APPLICATION WITH A MINIMUM I.57mm T

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NOTES:



3

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